

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Elka TOUITOU	10/15/2011
RECEIVING PARTY DATA	
Name:	YISSUM RESEARCH DEVELOPMENT COMPANY OF THE HEBREW UNIVERSITY OF JERUSALEM LTD.
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13137259
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ATTORNEY DOCKET NUMBER:	GPK-4110-225
NAME OF SUBMITTER:	Gordon P. Klancnik
Total Attachments: 1 source=4110_225_assignment#page1.tif	

OP \$40.00 13137259

ASSIGNMENT OF PATENT APPLICATION

(Inventors) Elka TOUITOU

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(Assignee) YISSUM RESEARCH DEVELOPMENT COMPANY OF THE HEBREW UNIVERSITY OF JERUSALEM LTD.

(Address) of High Tech Park, Edmond J. Safra Campus, P.O. Box 39135, Givat Ram, Jerusalem, Israel 91390

(Other Countries) (hereinafter designated as the Assignee) the undersigned's entire right, title and interest in the invention, and all application(s) for patent and any Letters Patent which may be granted therefor, known as

(Title) COMPOSITIONS FOR NAIL AND SKIN TREATMENT (Case No. 4110-225) for which the undersigned has (have) executed on even date herewith an application for patent in the United States of America or, if not on even date, then has executed on or has already filed in U.S. appln. Serial No. 13/137,259, filed on August 1, 2011.

The undersigned acknowledges an obligation of assignment of this invention to said assignee at the time the invention was made.

The undersigned agree(s) to execute all papers and documents necessary in connection with the application or any interference which may be declared and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient and further to perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the firm of NIXON & VANDERHUYE P.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document. It is understood and agreed that ASSIGNEE'S attorneys Nixon & Vanderhuy P.C. have represented only ASSIGNEE and will continue to represent only ASSIGNEE with respect to this invention.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned signature(s).

Date 15.10.2011 Signature of inventor


Elka TOUITOU